

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

### **DECLARATION FOR PATENT APPLICATION**

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

### "LIQUID MATERIAL SUPPLY SYSTEM"

the specification of which was filed October 27, 2003 as Application Serial No. 10/694,608.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment, if any, specifically referred to herein.

I acknowledge the duty to disclose all information known to me that is material to patentability in accordance with Title 37, Code of Federal Regulations, § 1.56.

### FOREIGN PRIORITY CLAIM

I hereby claim foreign priority benefits under Title 35, United States Code § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

	no such foreign applications have been filed .
x	such foreign application have been filed as follows

## EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
2003-043955	Japan	02/21/2003	x Yes No

# ALL FOREIGN APPLICATION(S), IF ANY FILED MORE THAN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION

Application Number	Country	Date of Filing (dd/mm/yyyy)
	,	

### CLAIM FOR BENEFIT OF EARLIER U.S. PROVISIONAL APPLICATIONS

I hereby claim priority benefits under	Title 35, United State	tes Code §119(e), of any	<ul> <li>United States provisional</li> </ul>
patent application(s) listed below:			

2	no such U.S. provisional applications have been filed.
	such U.S. provisional applications have been filed.  such U.S. provisional application have been filed as follows

Attorney Docket No.: 30732/39696

Application Number	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
		Yes No

### CLAIM FOR BENEFIT OF EARLIER U.S./PCT APPLICATION(S)

I hereby claim the benefit under Title 35, United States Code, §120 of the United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information that is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56 which became available to me between the filing date of the prior application and the national or PCT international filing date of this application:

x	no such U.S./PCT applications have been filed. such U.S./PCT application have been filed as follows:
-	such U.S./PCT application have been filed as follows:

Application Number	Date of Filing (dd/mm/yyyy)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint:

All practitioners at Customer Number 04743

all of MARSHALL, GERSTEIN & BORUN LLP, 233 S. Wacker Drive, Suite 6300, Sears Tower, Chicago, Illinois 60606-6357, jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the U. S. Patent and Trademark Office connected therewith.

Please mail all correspondence to Richard H. Anderson, whose address is:

### MARSHALL, GERSTEIN & BORUN LLP

233 S. Wacker Drive, Suite 6300 Sears Tower Chicago, Illinois 60606-6357

Please direct telephone calls to: Richard H. Anderson at (312) 474-9556.

Please direct facsimiles to: (312) 474-0448

Attorney Docket No.: 30732/39696

Full name of sole or first inventor  Sumio ONO  Sole or first inventor's signature  Residence Hyogo, Japan  Citizenship Japan  Mailing Address	7 ng J
Residence Hyogo, Japan Citizenship Japan	2 - 3
Residence Hyogo, Japan Citizenship Japan	د سرد
Hyogo, Japan  Citizenship Japan	
Hyogo, Japan  Citizenship Japan	2003
Citizenship Japan	
Mailing Address	
c/o Heishin Sobi Kabushiki Kaisha	
1-1-54, Misakihommachi, Hyogo-ku, Kobe	
Hyogo-pref. 652-0852 JAPAN	
JALAN	
Full name of second inventor, if any	
Hisatoshi IZUMI	
Second inventor's signature 4 Date	
Second inventor's signature of November 1	17 200
Residence 7K J J V DVE MOEY 1	1,00
Hyogo, Japan	
Citizenship Japan	
Mailing Address	
c/o Heishin Sobi Kabushiki Kaisha, Shiga Factory	
Higashimonobe, Takatsuki-cho, Ika-gun	İ
Shiga-pref. 529-0261	
JAPAN	
Full name of third inventor, if any	
Satoru KURAHASHI	
Third inventor's signature  Date	
启摘 蜓 November 11	· 2005
Residence	
Hyogo, Japan	
Citizenship Japan	
Mailing Address	-
c/o Heishin Sobi Kabushiki Kaisha, Shiga Factory	
Higashimonobe, Takatsuki-cho, Ika-gun	
Shiga-pref. 529-0261	
JAPAN	
Full name of fourth inventor, if any	
Yoshihiro SUGINO	
Fourth inventor's signature  Date	
拟野 样 引 November //	. 2003
Residence	
Hyogo, Japan	
Citizenship Japan	
Mailing Address	
c/o Heishin Sobi Kabushiki Kaisha, Shiga Factory	
Higashimonobe, Takatsuki-cho, Ika-gun	ļ
Shiga-pref. 529-0261	
JAPAN	

Attorney Docket No.: 30732/39696

Full name of fourth inventor, if any				
Nobuhisa SUHARA				
Fourth inventor's signature 損 原 1 本	Date November 11, 2003			
Residence				
Hyogo, Japan				
Citizenship Japan				
Mailing Address				
c/o Heishin Sobi Kabushiki Kaisha, Shiga Factory				
Higashimonobe, Takatsuki-cho, Ika-gun				
Shiga-pref. 529-0261				
JAPAN				